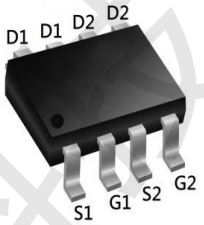
CST4892 Dual N-Ch 100V Fast Switching MOSFETs

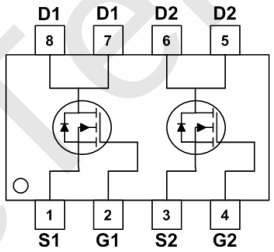
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

CST4892 Product Summary

BVDSS	RDSON	ID
100V	68mΩ	10.0 A

CST4892 SOP8 Pin Configuration





CST4892 Description

The CST4892 is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON a nd gate charge for most of the synchronous buck c onverter applications.

The CST4892 meet the RoHS and Green Product requirement with full function reliability approved.

CST4892 Absolute Maximum Ratings（T_A = 25°C, unless otherwise noted）

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_A=25°C	I_D	10	A
	T_A=100°C		3.5	
Pulsed Drain Current[1]		I_{DM}	16	A
Single Pulse Avalanche Energy[2]		EAS	3.2	mJ
Total Power Dissipation	T_A=25°C	P_D	3.1	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

CST4892 Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient[3]	$R_{\theta JA}$	40.3	°C/W

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CST4892 Electrical Characteristics（T_J= 25°C, unless otherwise noted）

Parameter		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	100	-	-	V
Gate-Body Leakage Current		I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T_J=25°C	I_{DSS}	V_{DS} =100V, V_{GS} = 0V	-	-	1	μA
	T_J=100°C			-	-	100	
Gate-Threshold Voltage		$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1	1.7	3	V
Drain-Source on-Resistance[4]		$R_{DS(on)}$	V_{GS} = 10V, I_D = 4A	-	68	100	mΩ
			V_{GS} = 4.5V, I_D = 2A	-	78	110	
Forward Transconductance[4]		g_{fs}	V_{DS}=10V , I_D=4A	-	11	-	S
Dynamic Characteristics[5]							
Input Capacitance		C_{iss}	V_{DS} = 50V, V_{GS} =0V, f =1MHz	-	1233	-	pF
Output Capacitance		C_{oss}		-	32	-	
Reverse Transfer Capacitance		C_{rss}		-	26	-	
Gate Resistance		R_g	f =1MHz	-	1.4	-	Ω
Switching Characteristics[5]							
Total Gate Charge		Q_g	V_{GS} = 10V, V_{DS} = 50V, I_D=4A	-	12	-	nC
Gate-Source Charge		Q_{gs}		-	2.9	-	
Gate-Drain Charge		Q_{gd}		-	1.8	-	
Turn-on Delay Time		$t_{d(on)}$	V_{GS} =10V, V_{DD} =50V, R_G = 3Ω, I_D= 4A	-	3.9	-	ns
Rise Time		t_r		-	26	-	
Turn-off Delay Time		$t_{d(off)}$		-	16.2	-	
Fall Time		t_f		-	8.9	-	
Body Diode Reverse Recovery Time		t_{rr}	I_F = 4A, dI/dt=100A/μs	-	40	-	ns
Body Diode Reverse Recovery Charge		Q_{rr}		-	43	-	nC
Drain-Source Body Diode Characteristics							
Diode Forward Voltage[4]		V_{SD}	I_S = 1A, V_{GS} = 0V	-	-	1.2	V
Continuous Source Current	T_A=25°C	I_S	-	-	-	10	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150°C.
2. The EAS data shows Max. rating . The test condition is V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}= 8A .
3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
4. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
5. This value is guaranteed by design hence it is not included in the production test..

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CST4892 Typical Characteristics

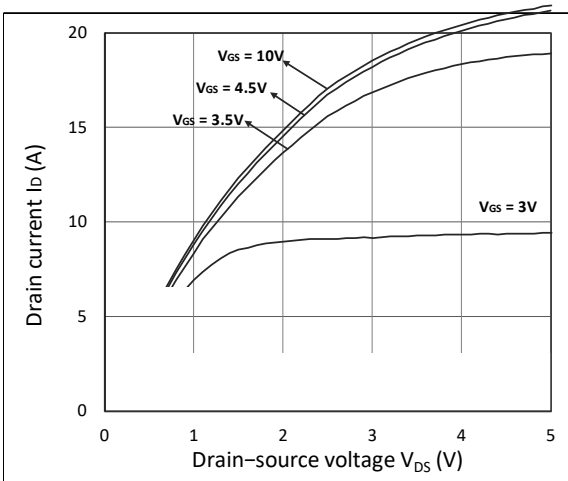


Figure 1. Output Characteristics

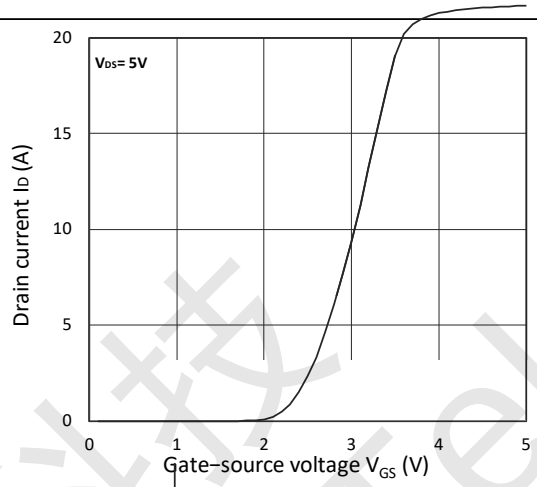


Figure 2. Transfer Characteristics

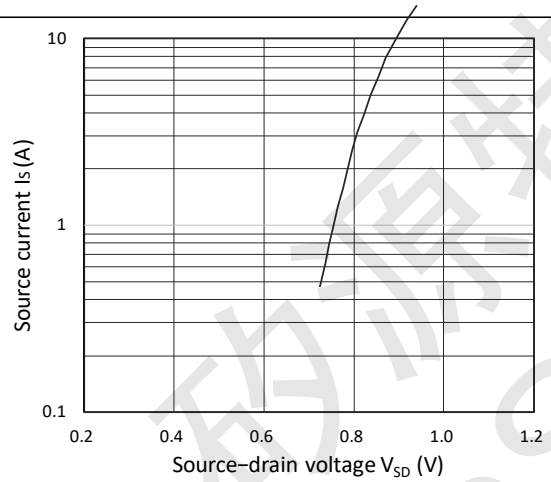


Figure 3. Forward Characteristics of Reverse

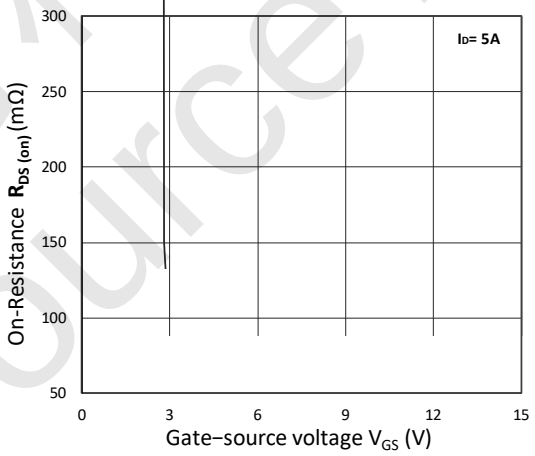


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

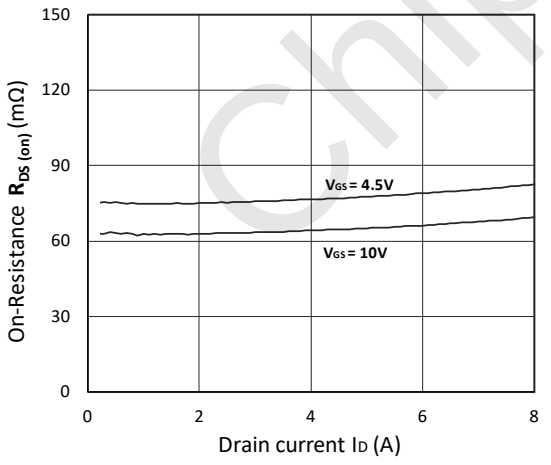


Figure 5. $R_{DS(ON)}$ vs. I_D

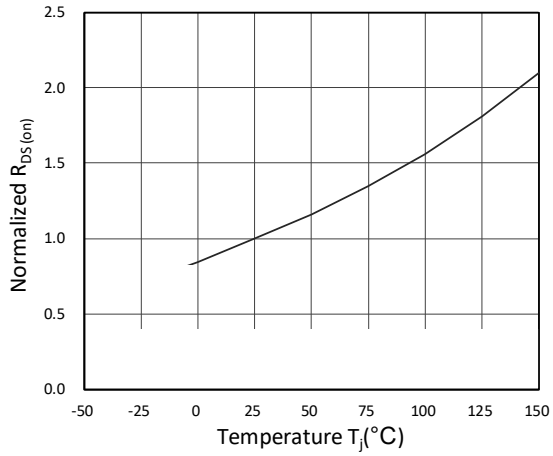


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

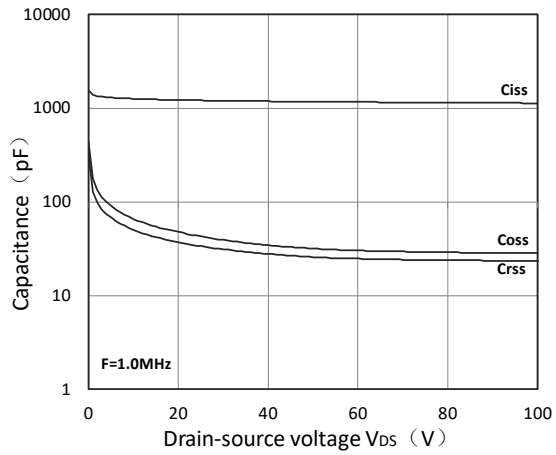


Figure 7. Capacitance Characteristics

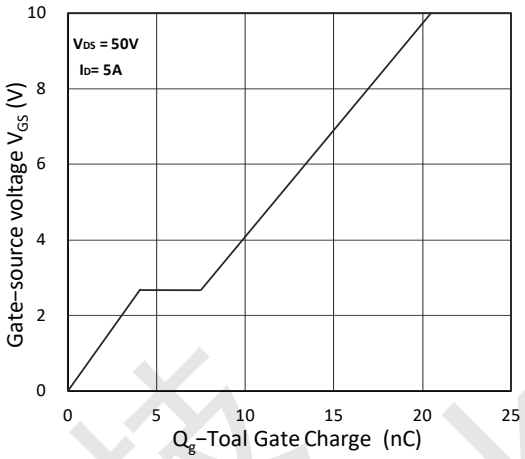


Figure 8. Gate Charge Characteristics

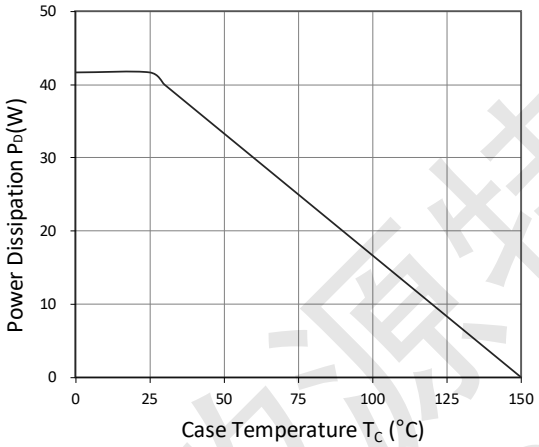


Figure 9. Power Dissipation

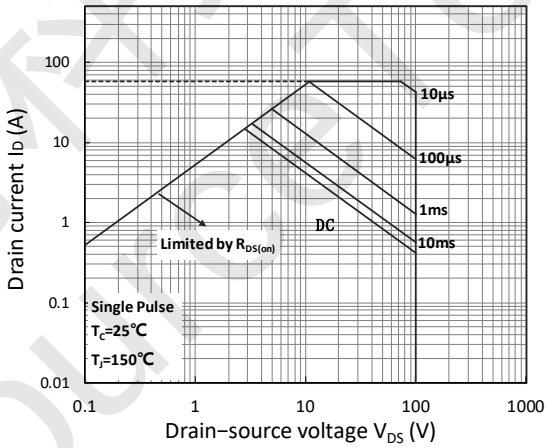


Figure10. Safe Operating Area

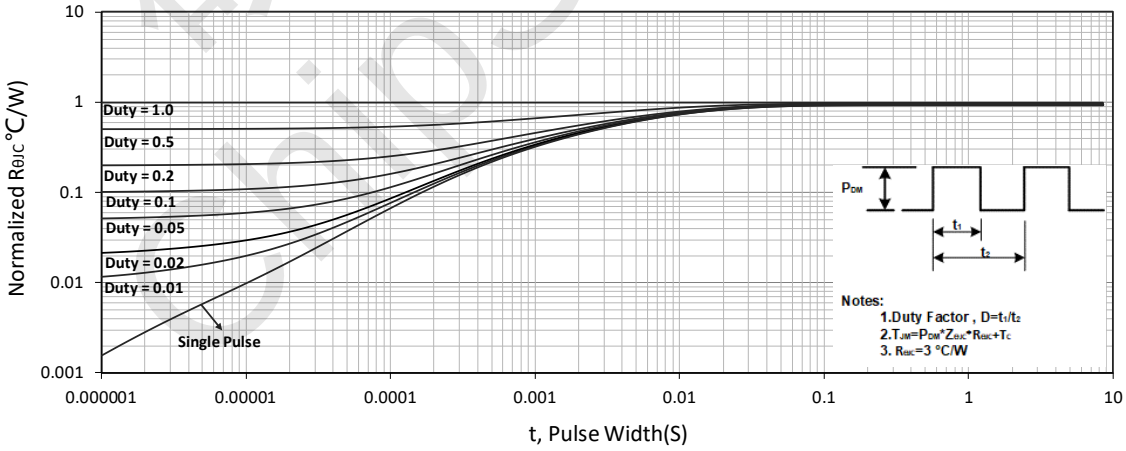
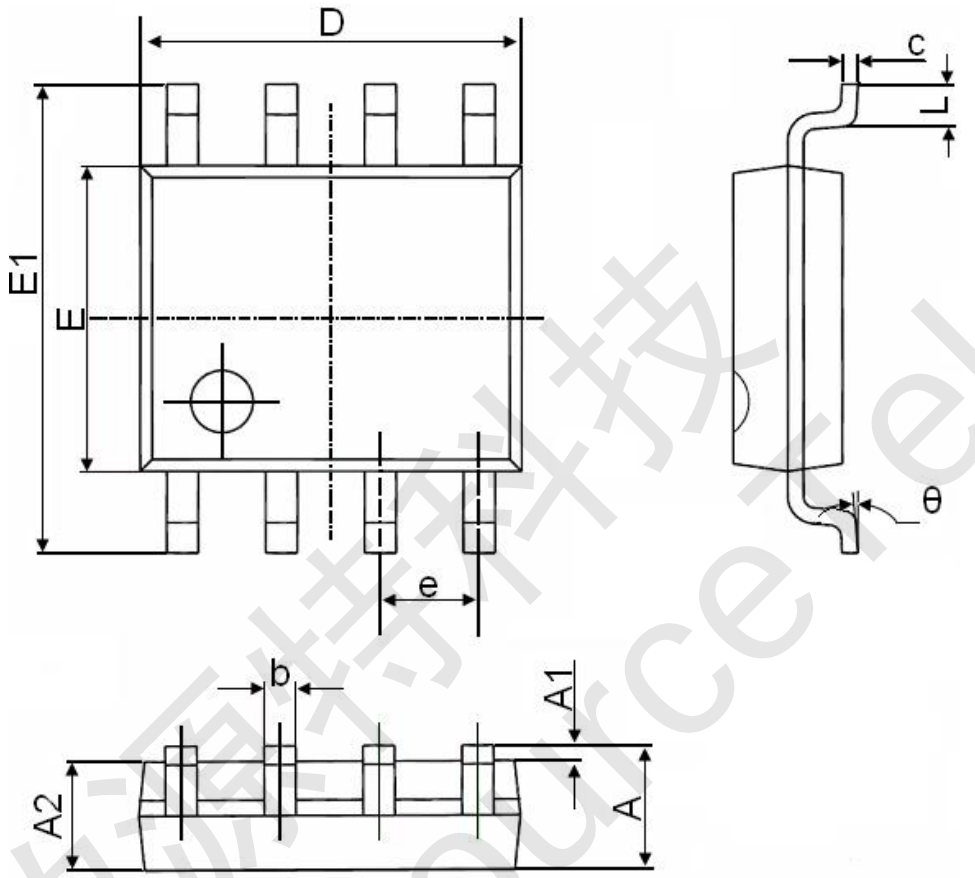


Figure 11. Normalized Maximum Transient Thermal Impedance

CST4892 SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°